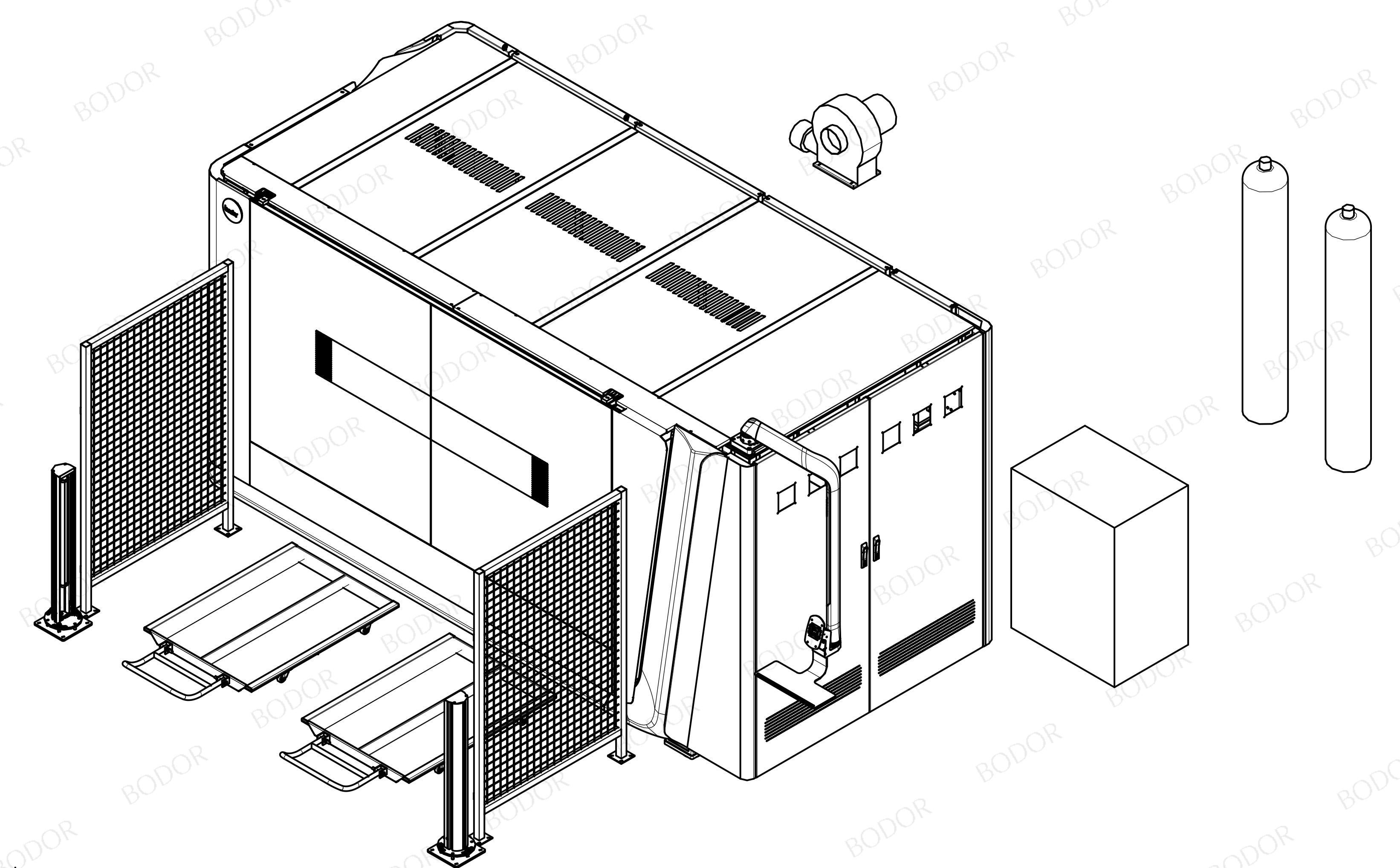
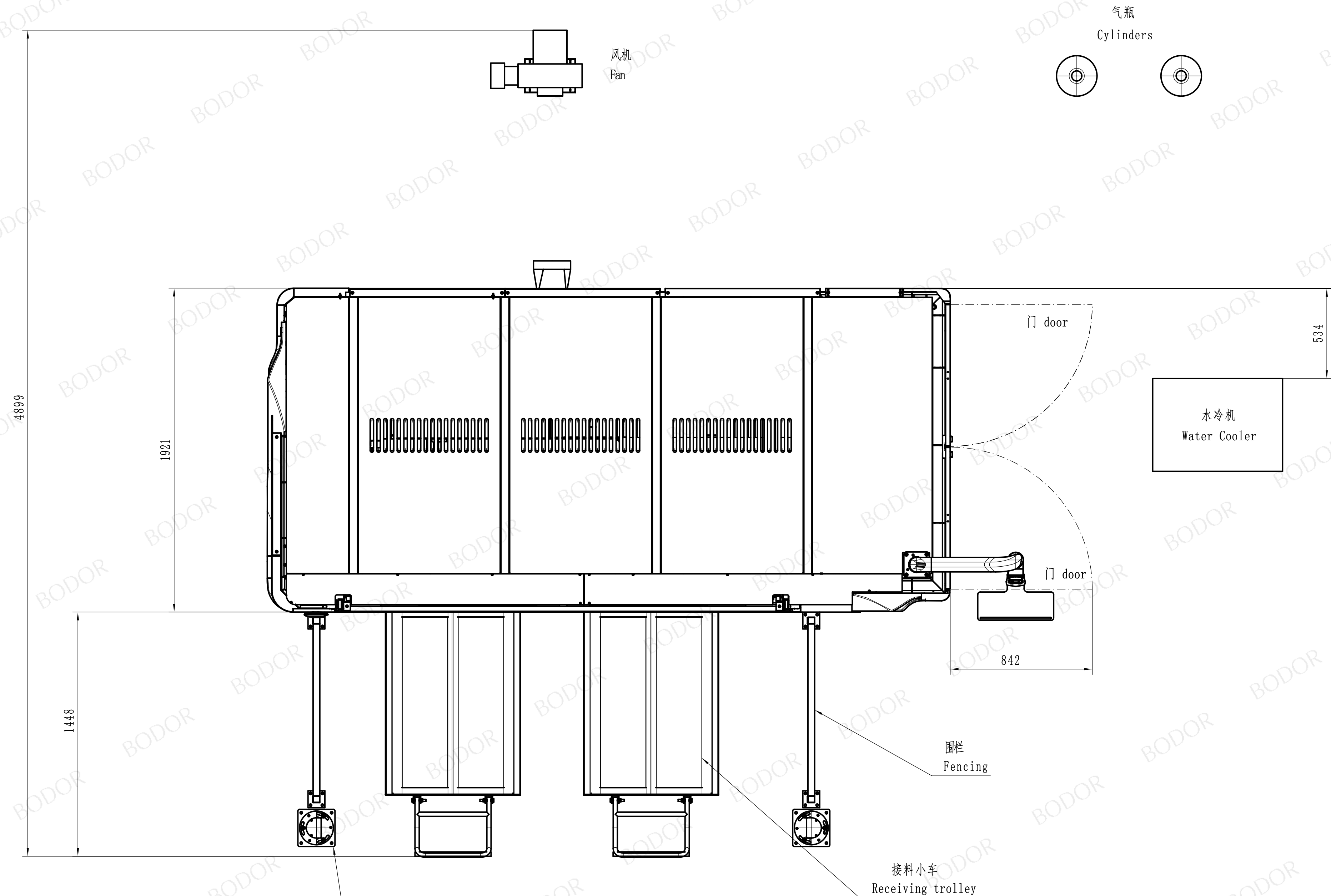
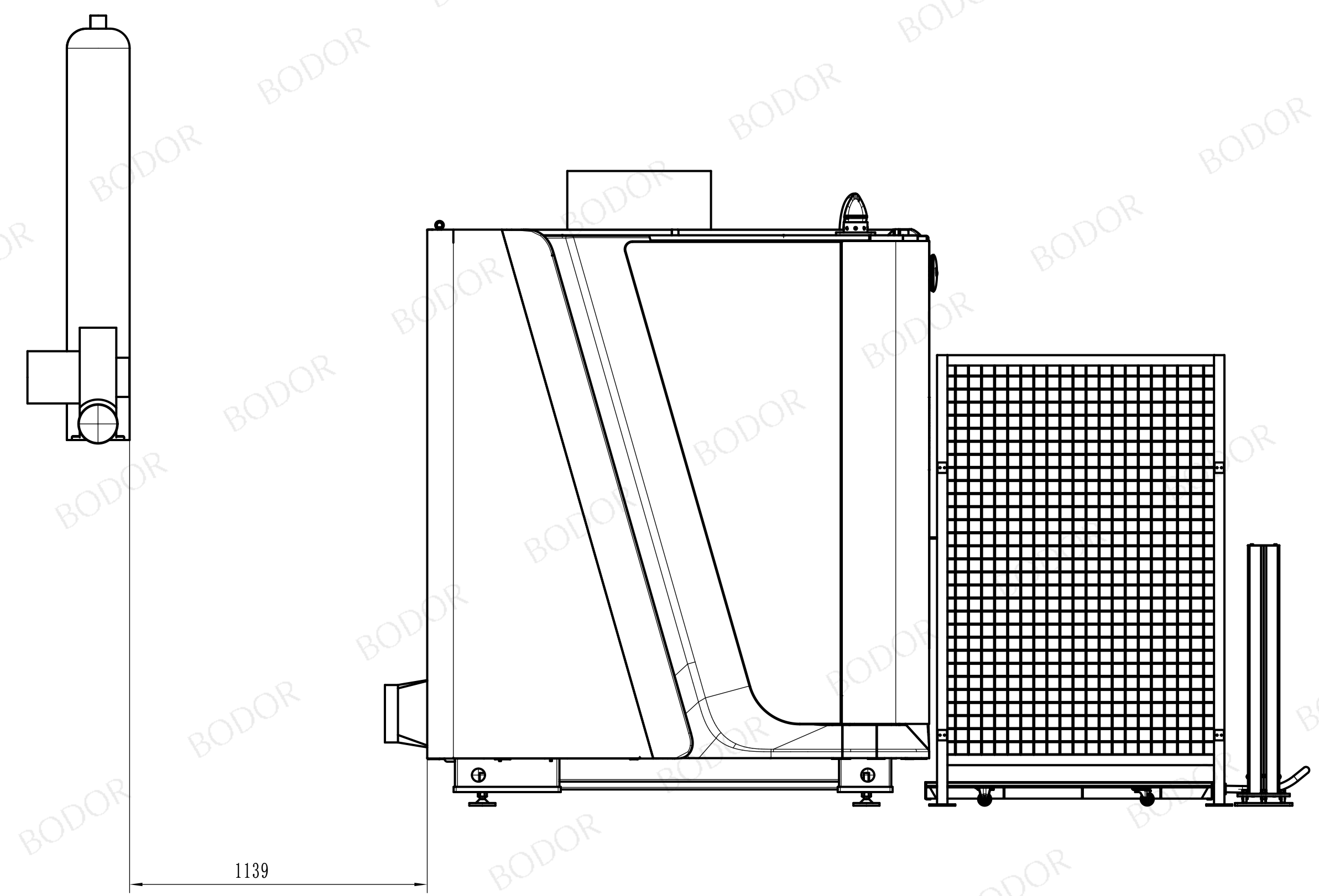
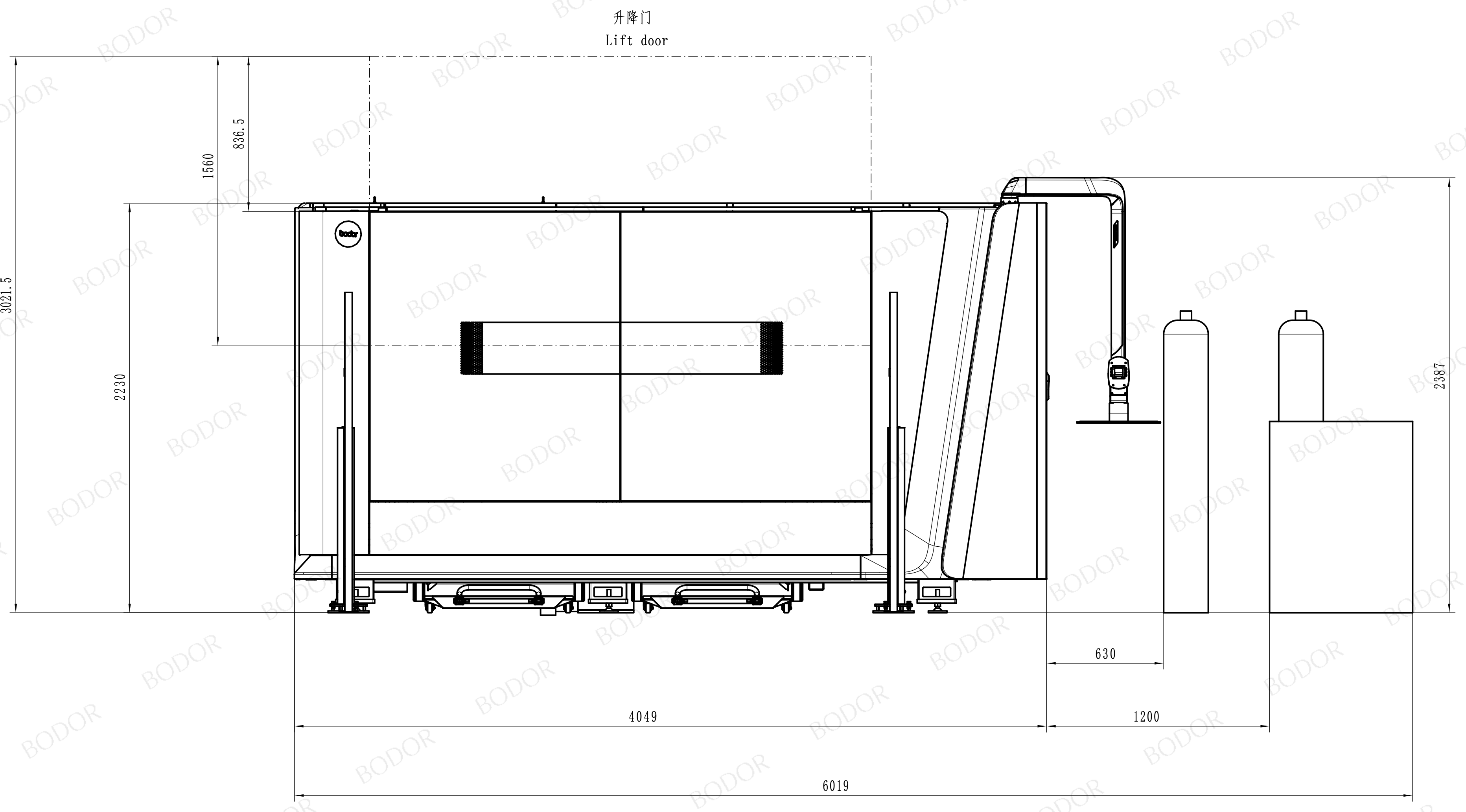


i6 V3.5 现场布局图
i6 V3.5 site layout



- 就位要求:
1. 整机四周障碍物至少1m.
 2. 整机应远离震源.
 3. 整机就位时地平面浮动应不大于5mm.
 4. 整机接入电压浮动在±5%以内.
 5. 若图示区域增设辅助设备请联系邦德确认.
 6. 本布置图的设备位置仅供参考, 实际摆放可根据现场实际情况而定.
 7. 安全光幕及围栏为GB标准配置, GB及CU版本为非标配置, 为客户选配.

- Initiation Requirement:
1. The whole machine is at least 1m away from obstacles.
 2. The whole machine should be away from the earthquake source.
 3. The leveling of the whole machine should be less than 5mm.
 4. The whole machine's access voltage fluctuates within (+5%).
 5. Please contact Bond for confirmation if additional auxiliary equipment is installed in the illustrated area.
 6. The location of the equipment in this layout is for reference only.
 7. Safety screen and fence for CE standard configuration, GB and CU version for non-standard configuration, for customers to choose.

ERP号及版本										济南邦德激光股份有限公司 Bodor Laser CO., Ltd.	
i6 V3.5 现场布局图										i6 V3.5 site layout	
标记	处数	分区	更改文件号	签名	年月日	阶段标记	质量	比例	i6-V3.5-XB		
设计							0.00kg	1:16			
审核											
共6张 第1张										版本	

零件代号	
依(德)国零件代号	
插图	
备注	
图框图号	
图框图号	
签字	
日期	